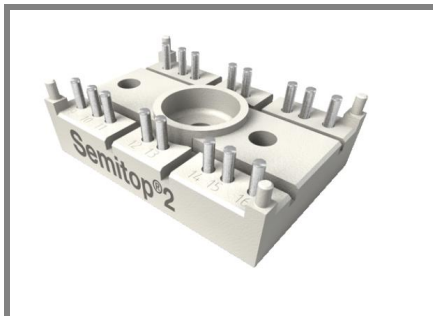


# SK 75 TAA



**SEMITOP®2**

## Two separated thyristors

### SK 75 TAA

#### Target Data

#### Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DBC)
- Glass passivated thyristor chips
- Up to 1600 reverse voltage
- High surge currents

#### Typical Applications

- Brake chopper
- Soft starters

$V_{RSM}$ V	$V_{RRM}, V_{DRM}$ V	$I_T = 75$ A ( $T_s = 80$ °C)
900	800	SK75TAA08
1300	1200	SK75TAA12
1700	1600	SK75TAA16

#### Characteristics $T_s = 25$ °C unless otherwise specified

Symbol	Conditions	Values	Units
$I_T$	$T_s = 100$ °C	47	A
$I_T$	$T_s = 80$ °C	75	A
			A
$I_{TSM}/I_{FSM}$	$T_{vj} = 25$ (125) °C; 10 ms	1500 (1350)	A
$I^2t$	$T_{vj} = 25$ (125) °C; half sine wave, 10 ms	11250 (9100)	A <sup>2</sup> s
$T_{stg}$		-40 ... +125	°C
$T_{solder}$	terminals, 10 s	260	°C

#### Thyristor

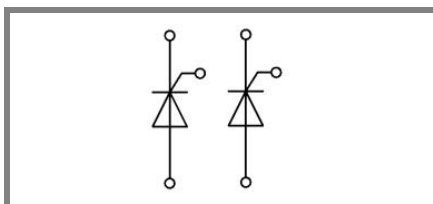
$(dv/dt)_{cr}$	$T_{vj} = 125$ °C	1000	V/ $\mu$ s
$(di/dt)_{cr}$	$T_{vj} = 125$ °C; $f = 50 \dots 60$ Hz	50	A/ $\mu$ s
$t_q$	$T_{vj} = 125$ °C; typ.	80	$\mu$ s
$I_H$	$T_{vj} = 25$ °C; typ. / max.	100 / 200	mA
$I_L$	$T_{vj} = 25$ °C; $R_G = 33 \Omega$ ; typ. / max.	200 / 500	mA
$V_T$	$T_{vj} = 25$ °C; ( $I_T = 200$ A); max.	1,8	V
$V_{T(TO)}$	$T_{vj} = 125$ °C	max. 0,9	V
$r_T$	$T_{vj} = 125$ °C	max. 4,5	m $\Omega$
$I_{DD}, I_{RD}$	$T_{vj} = 125$ °C; $V_{DD} = V_{DRM}, V_{RD} = V_{RRM}$	max. 20	mA
$R_{th(j-s)}$	cont. per thyristor	0,6	K/W
$T_{vj}$		-40 ... +125	°C
$V_{GT}$	$T_{vj} = 25$ °C; d.c.	2	V
$I_{GT}$	$T_{vj} = 25$ °C; d.c.	100	mA
$V_{GD}$	$T_{vj} = 125$ °C; d.c.	0,25	V
$I_{GD}$	$T_{vj} = 125$ °C; d.c.	5	mA

#### Diode

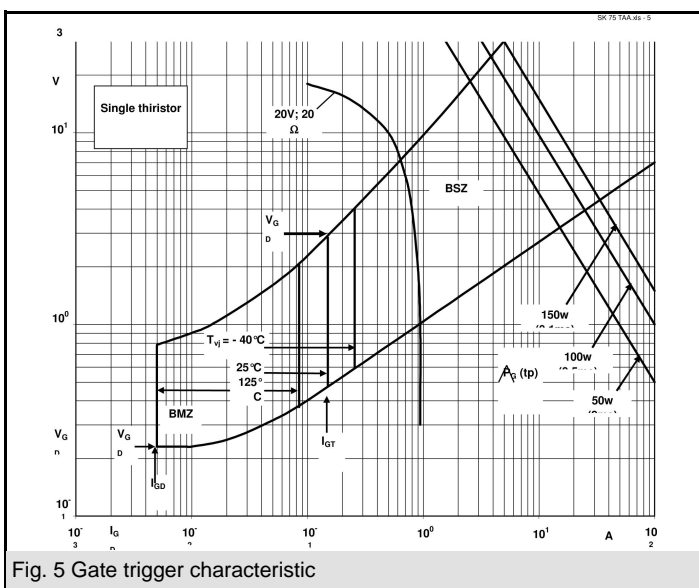
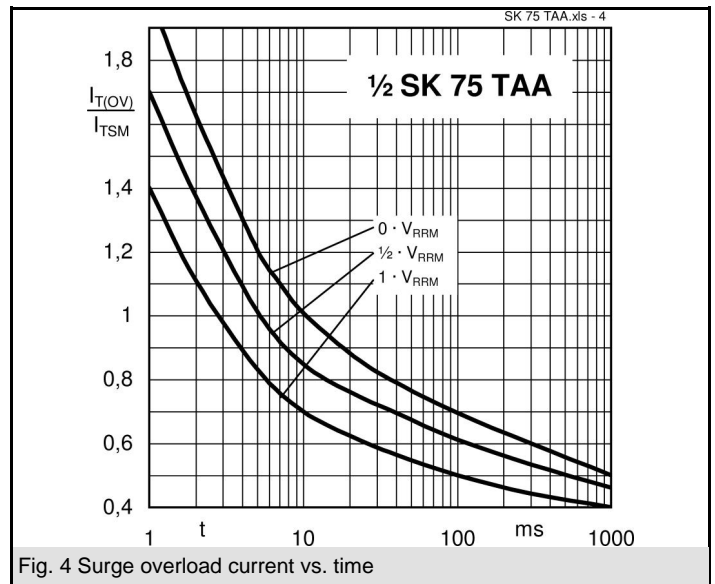
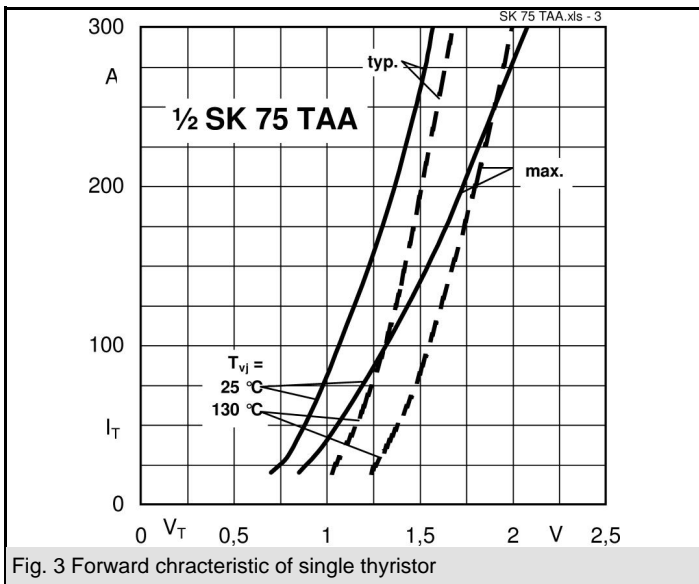
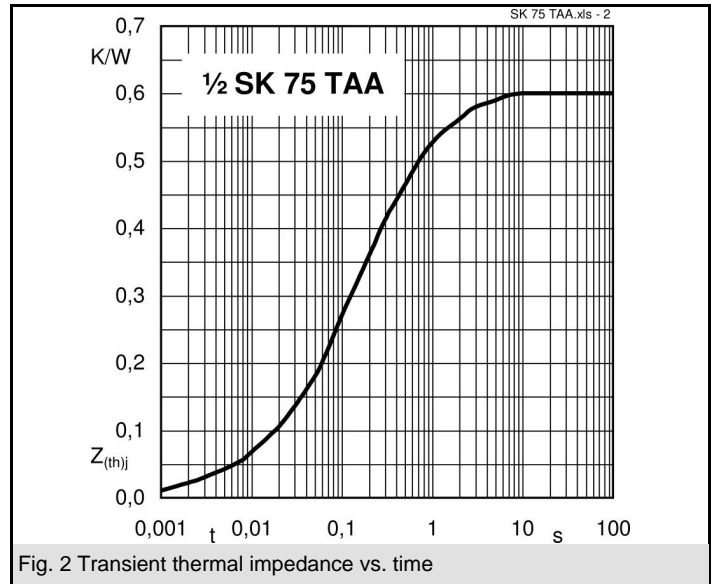
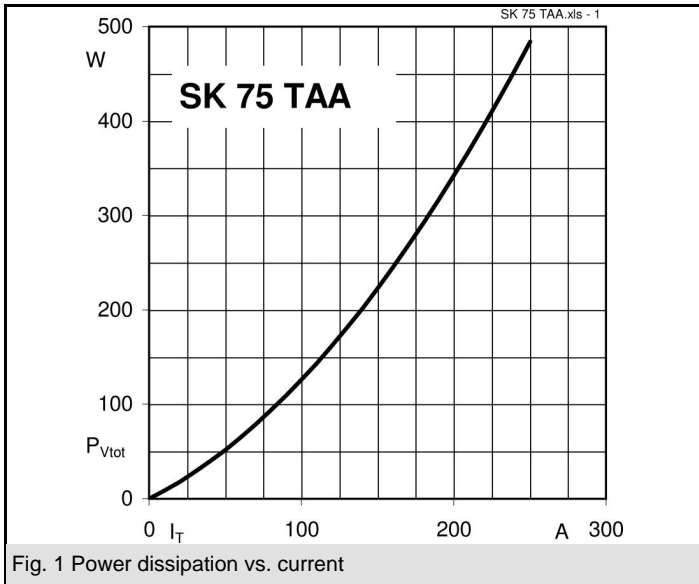
$V_F$	$T_{vj} =$ °C; ( $I_F =$ A); max.		V
$V_{(TO)}$	$T_{vj} =$ °C		V
$r_T$	$T_{vj} =$ °C		m $\Omega$
$I_{RD}$	$T_{vj} =$ °C; $V_{RD} = V_{RRM}$		mA
$R_{th(j-s)}$			K/W
$T_{vj}$			°C

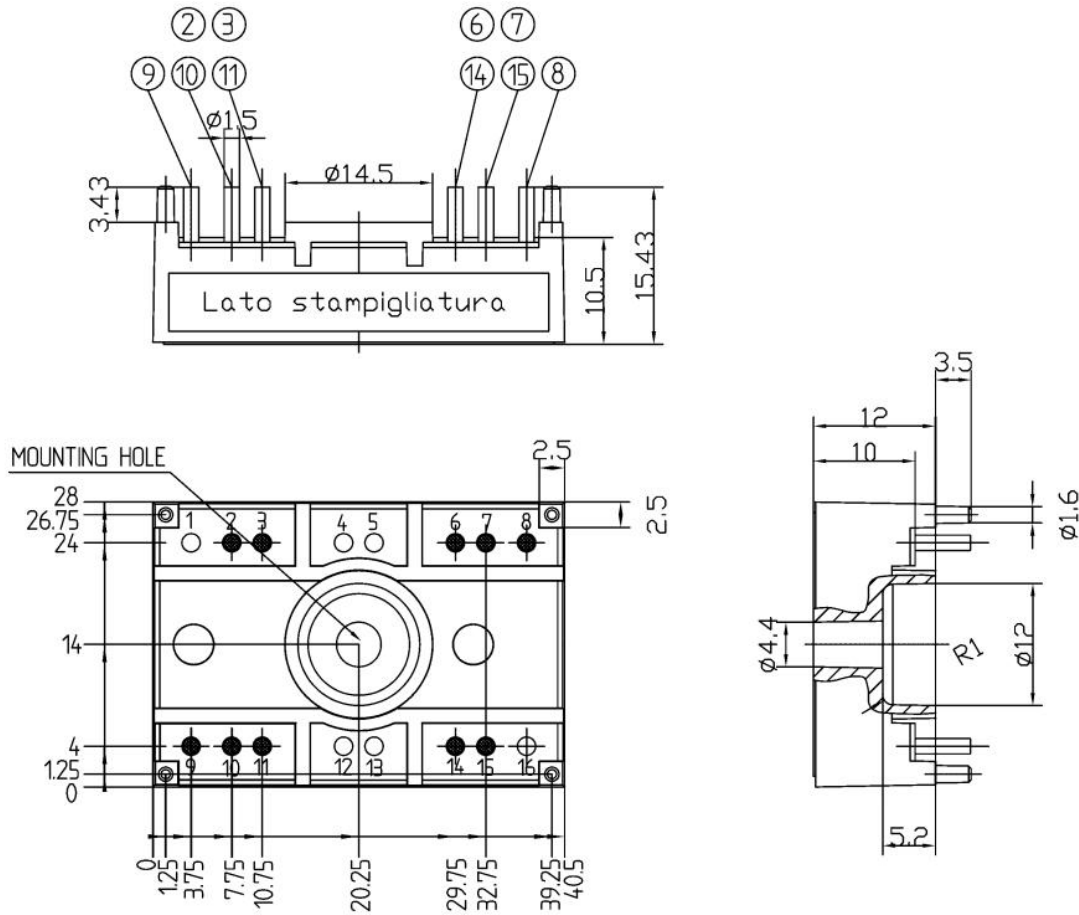
#### Mechanical data

$V_{isol}$	AC 50Hz, r.m.s. 1min (1sec)	2500 (3000)	V
$M_1$	mounting torque	2	Nm
w		19	g
Case	SEMITOP®2	T 81	



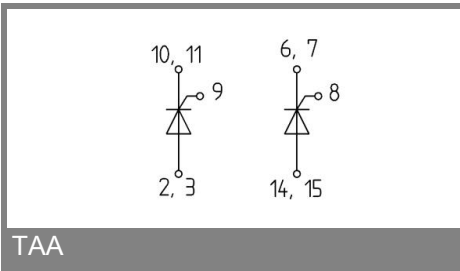
TAA





SUGGESTED HOLEDIAMETER FOR THE SOLDER PINS AND THE MOUNTING PINS IN THE PCB: 2 mm

Case T 81 (Suggested hole diameter, in the PCB, for solder pins and plastic mounting pins: 2mm)



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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